

## Miniature I<sup>2</sup>C Digital Barometer

The MPL115A2 is an absolute pressure sensor with a digital I<sup>2</sup>C output targeting low cost applications. A miniature 5 by 3 by 1.2 mm LGA package is ideally suited for the space constrained requirements of portable electronic devices. Low current consumptions of 5  $\mu$ A during Active mode and 1  $\mu$ A during Shutdown (Sleep) mode are essential when focusing on low-power applications. The wide operating temperature range spans from -40°C to +105°C to fit demanding environmental conditions.

The MPL115A2 employs a MEMS pressure sensor with a conditioning IC to provide accurate pressure measurements from 50 to 115 kPa. An integrated ADC converts pressure and temperature sensor readings to digitized outputs via a I<sup>2</sup>C port. Factory calibration data is stored internally in an on-board ROM. Utilizing the raw sensor output and calibration data, the host microcontroller executes a compensation algorithm to render *Compensated Absolute Pressure* with  $\pm 1$  kPa accuracy.

The MPL115A2 pressure sensor's small form factor, low power capability, precision, and digital output optimize it for barometric measurement applications.

### Features

- Digitized pressure and temperature information together with programmed calibration coefficients for host micro use.
- Factory Calibrated
- 50 kPa to 115 kPa Absolute Pressure
- $\pm 1$  kPa Accuracy
- 2.375V to 5.5V Supply
- Integrated ADC
- I<sup>2</sup>C Interface (operates up to 400 kHz)
- 7 bit I<sup>2</sup>C address = 0x60
- Monotonic Pressure and Temperature Data Outputs
- Surface Mount RoHS Compliant Package

### Application Examples

- Barometry (portable and desktop)
- Altimeters
- Weather Stations
- Hard Disk-Drives (HDD)
- Industrial Equipment
- Health Monitoring
- Air Control Systems

## MPL115A2

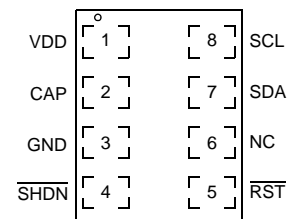
50 to 115 kPa



### MPL115A2

5.0 mm by 3.0 mm by 1.2 mm

### Top View



### Pin Connections

### ORDERING INFORMATION

Device Name	Package Options	Case No.	# of Ports			Pressure Type			Digital Interface
			None	Single	Dual	Gauge	Differential	Absolute	
MPL115A2	Tray	2015	•					•	I <sup>2</sup> C
MPL115A2T1	Tape & Reel (1000)	2015	•					•	I <sup>2</sup> C
MPL115A2T2	Tape & Reel (5000)	2015	•					•	I <sup>2</sup> C

# 1 Block Diagram and Pin Descriptions

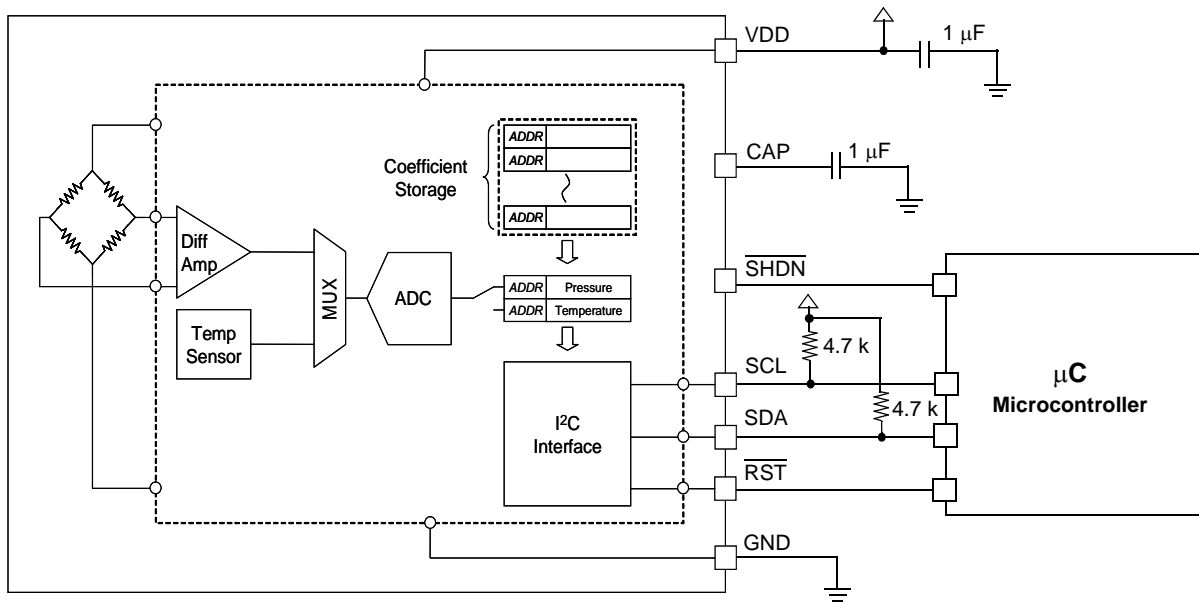


Figure 1. Block Diagram and Pin Connections

Table 1. Pin Description

Pin	Name	Function
1	VDD	VDD Power Supply Connection: VDD range is 2.375V to 5.5V.
2	CAP	1 $\mu$ F connected to ground.
3	GND	Ground
4	$\overline{\text{SHDN}}$	Shutdown: Connect to GND to disable the device. When in shutdown, the part draws no more than 1 $\mu$ A supply current and all communications pins ( $\overline{\text{RST}}$ , SCL, SDA) are high impedance. Connect to VDD for normal operation.
5	$\overline{\text{RST}}$	Reset: Connect to ground to disable I <sup>2</sup> C communications.
6	NC	NC: No connection
7	SDA <sup>(1)</sup>	SDA: Serial data I/O line
8	SCL <sup>(1)</sup>	I <sup>2</sup> C Serial Clock Input.

1. Use 4.7k pullup resistors for I<sup>2</sup>C communication.

## 2 Mechanical and Electrical Specifications

### 2.1 Maximum Ratings

Voltage (with respect to GND unless otherwise noted)

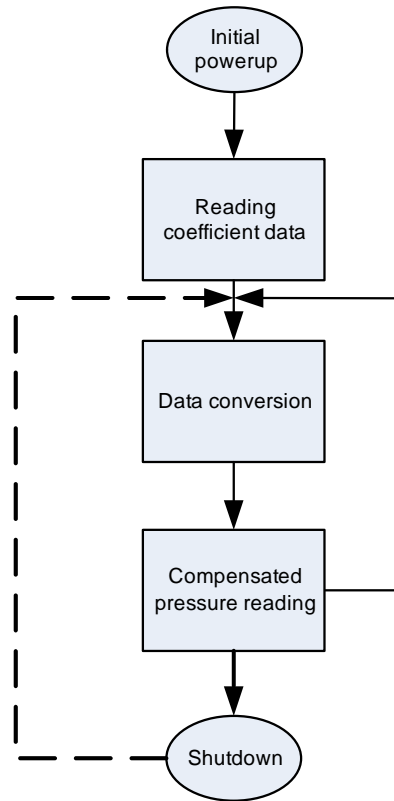
$V_{DD}$ .....	-0.3 V to +5.5 V
$\overline{SHDN}$ , RST, SDA, SCL .....	-0.3 V to $V_{DD}+0.3$ V
Operating Temperature Range .....	-40°C to +105°C
Storage Temperature Range .....	-40°C to +125°C
Overpressure .....	1000 kPa

### 2.2 Operating Characteristics

$V_{DD}$  = 2.375 V to 5.5 V,  $T_A$  = -40°C to +105°C, unless otherwise noted. Typical values are at  $V_{DD}$  = 3.3 V,  $T_A$  = +25°C.

Ref	Parameters	Symbol	Conditions	Min	Typ	Max	Units
1	Operating Supply Voltage	$V_{DD}$		2.375	3.3	5.5	V
2	Supply Current	$I_{DD}$	Shutdown ( $\overline{SHDN}$ = GND)	—	—	1	$\mu$ A
			Standby	—	3.5	10	$\mu$ A
			Average – at one measurement per second	—	5	6	$\mu$ A
<b>Pressure Sensor</b>							
3	Range			50	—	115	kPa
4	Resolution			—	0.15	—	kPa
5	Accuracy		-20°C to 85°C	—	—	$\pm 1$	kPa
6	Power Supply Rejection		Typical operating circuit at DC		0.1	—	kPa/V
			100 mV p-p 217 Hz square wave plus 100 mV pseudo random noise with 10 MHz bandwidth		0.1	—	kPa
7	Conversion Time ( <i>Start Pressure and Temperature Conversion</i> )	$t_c$	Time between start convert command and data available in the Pressure and Temperature registers	—	1.6	3	ms
8	Wakeup Time	$t_w$	Time between leaving Shutdown mode ( $\overline{SHDN}$ goes high) and communicating with the device to issue a command or read data.	—	3	5	ms
<b>I<sup>2</sup>C I/O Stages: SCL, SDA</b>							
9	SCL Clock Frequency	$f_{SCL}$		—	—	400	kHz
10	Low Level Input Voltage	$V_{IL}$		—	—	$0.3V_{DD}$	V
11	High Level Input Voltage	$V_{IH}$		$0.7V_{DD}$	—	—	V
<b>I<sup>2</sup>C Outputs: SDA</b>							
12	Data Setup Time	$t_{SU}$	Setup time from command receipt to ready to transmit	0	—	0.4	s
<b>I<sup>2</sup>C Addressing</b>							
MPL115A2 uses 7-bit addressing, does not acknowledge the general call address 0000000. Slave address has been set to 0x60 or 1100000.							

### 3 Overview of Functions/Operation



**Figure 2. Sequence Flow Chart**

The MPL115A interfaces to a host (or system) microcontroller in the user's application. All communications are via I<sup>2</sup>C. A typical usage sequence is as follows:

#### **Initial Power-up**

All circuit elements are active. I<sup>2</sup>C port pins are high impedance and associated registers are cleared. The device then enters standby mode.

#### **Reading Coefficient Data**

The user then typically accesses the part and reads the coefficient data. The main circuits within the slave device are disabled during read activity. The coefficients are usually stored in the host microcontroller local memory but can be re-read at any time.

It is not necessary to read the values stored in the host microcontroller multiple times because the coefficients within a device are constant and do not change. However, note that the coefficients will be different from device to device, and cannot be used for another part.

#### **Data Conversion**

This is the first step that is performed each time a new pressure reading is required which is initiated by the host sending the CONVERT command. The main system circuits are activated (wake) in response to the command and after the conversion completes, the result is placed into the Pressure and Temperature ADC output registers.

The conversion completes within the maximum conversion time,  $t_c$  (see [Row 7](#), in the Operating Characteristics Table). The device then enters standby mode.

#### **Compensated Pressure Reading**

After the conversion has been given sufficient time to complete, the host microcontroller reads the result from the ADC output registers and calculates the Compensated Pressure, a barometric/atmospheric pressure value which is compensated for changes in temperature and pressure sensor linearity. This is done using the coefficient data from the MPL115A and the raw sampled pressure and temperature ADC output values, in a compensation equation (detailed later). Note that this is an absolute pressure measurement with a vacuum as a reference.

From this step the host controller may either wait and then return to the Data Conversion step to obtain the next pressure reading or it may go to the Shutdown step.

## Shutdown

For longer periods of inactivity the user may assert the  $\overline{\text{SHDN}}$  input by driving this pin low to reduce system power consumption. This removes power from all internal circuits, including any registers. In the shutdown state, the Pressure and Temperature registers will be reset, losing any previous ADC output values.

This step is exited by taking the  $\overline{\text{SHDN}}$  pin high. Wait for the maximum wakeup time,  $t_w$  (see [Row 8](#), in the Operating Characteristics Table), after which another pressure reading can be taken by transitioning to the data Conversion step.

**Table 2. Device Memory Map**

Address	Name	Description	Size (bits)
0x00	Padc_MSB	10-bit Pressure ADC output value MSB	8
0x01	Padc_LSB	10-bit Pressure ADC output value LSB	2
0x02	Tadc_MSB	10-bit Temperature ADC output value MSB	8
0x03	Tadc_LSB	10-bit Temperature ADC output value LSB	2
0x04	a0_MSB	a0 coefficient MSB	8
0x05	a0_LSB	a0 coefficient LSB	8
0x06	b1_MSB	b1 coefficient MSB	8
0x07	b1_LSB	b1 coefficient LSB	8
0x08	b2_MSB	b2 coefficient MSB	8
0x09	b2_LSB	b2 coefficient LSB	8
0x0A	c12_MSB	c12 coefficient MSB	8
0x0B	c12_LSB	c12 coefficient LSB	8
0x0C	Reserved*	—	—
0x0D	Reserved*	—	—
0x0E	Reserved*	—	—
0x0F	Reserved*	—	—
0x10	Reserved	—	—
0x11	Reserved	—	—
0x12	CONVERT	Start Pressure and Temperature Conversion	—

\*These registers are set to 0x00. These are reserved, and were previously utilized as Coefficient values, c11 and c22, which were always 0x00.

For values with less than 16 bits, the lower LSBs are zero. For example, c12 is 14 bits and is stored into 2 bytes as follows:

$$\text{c12 MS byte} = \text{c12}[13:6] = [\text{c12}_{b13}, \text{c12}_{b12}, \text{c12}_{b11}, \text{c12}_{b10}, \text{c12}_{b9}, \text{c12}_{b8}, \text{c12}_{b7}, \text{c12}_{b6}]$$

$$\text{c12 LS byte} = \text{c12}[5:0] \ \& \ \text{"00"} = [\text{c12}_{b5}, \text{c12}_{b4}, \text{c12}_{b3}, \text{c12}_{b2}, \text{c12}_{b1}, \text{c12}_{b0}, 0, 0]$$

### 3.1 Pressure, Temperature and Coefficient Bit-Width Specifications

The table below specifies the initial coefficient bit-width specifications for the compensation algorithm and the specifications for Pressure and Temperature ADC values.

Pressure, Temperature and Compensation Coefficient Specifications						
	a0	b1	b2	c12	Padc	Tadc
<b>Total Bits</b>	16	16	16	14	10	10
<b>Sign Bits</b>	1	1	1	1	0	0
<b>Integer Bits</b>	12	2	1	0	10	10
<b>Fractional Bits</b>	3	13	14	13	0	0
<b>dec pt zero pad</b>	0	0	0	9	0	0

### Example Binary Format Definitions:

a0 Signed, Integer Bits = 12, Fractional Bits = 3 :

b1 Signed, Integer Bits = 2, Fractional Bits = 7 :

b2 Signed, Integer Bits = 1, Fractional Bits = 14 :

c12 Signed, Integer Bits = 0, Fractional Bits = 13, dec pt zero pad = 9 :

Padc Unsigned, Integer Bits = 10 :

Tadc Unsigned, Integer Bits = 10 :

Coeff a0 = S I<sub>11</sub> I<sub>10</sub> I<sub>9</sub> I<sub>8</sub> I<sub>7</sub> I<sub>6</sub> I<sub>5</sub> I<sub>4</sub> I<sub>3</sub> I<sub>2</sub> I<sub>1</sub> I<sub>0</sub> . F<sub>2</sub> F<sub>1</sub> F<sub>0</sub>

Coeff b1 = S I<sub>1</sub> I<sub>0</sub> . F<sub>12</sub> F<sub>10</sub> F<sub>9</sub> F<sub>8</sub> F<sub>7</sub> F<sub>6</sub> F<sub>5</sub> F<sub>4</sub> F<sub>3</sub> F<sub>2</sub> F<sub>1</sub> F<sub>0</sub>

Coeff b2 = S I<sub>0</sub> . F<sub>13</sub> F<sub>12</sub> F<sub>10</sub> F<sub>9</sub> F<sub>8</sub> F<sub>7</sub> F<sub>6</sub> F<sub>5</sub> F<sub>4</sub> F<sub>3</sub> F<sub>2</sub> F<sub>1</sub> F<sub>0</sub>

Coeff c12 = S 0 . 000 000 000 F<sub>12</sub> F<sub>10</sub> F<sub>9</sub> F<sub>8</sub> F<sub>7</sub> F<sub>6</sub> F<sub>5</sub> F<sub>4</sub> F<sub>3</sub> F<sub>2</sub> F<sub>1</sub> F<sub>0</sub>

Padc U = I<sub>9</sub> I<sub>8</sub> I<sub>7</sub> I<sub>6</sub> I<sub>5</sub> I<sub>4</sub> I<sub>3</sub> I<sub>2</sub> I<sub>1</sub> I<sub>0</sub>

Tadc U = I<sub>9</sub> I<sub>8</sub> I<sub>7</sub> I<sub>6</sub> I<sub>5</sub> I<sub>4</sub> I<sub>3</sub> I<sub>2</sub> I<sub>1</sub> I<sub>0</sub>

**NOTE:** Negative coefficients are coded in 2's complement notation.

## 3.2 Compensation

The 10-bit compensated pressure output, Pcomp, is calculated as follows:

$$P_{comp} = a_0 + (b_1 + c_{12} \cdot T_{adc}) \cdot P_{adc} + b_2 \cdot T_{adc}$$

**Eqn. 1**

Where:

Padc is the 10-bit pressure ADC output of the MPL115A

Tadc is the 10-bit temperature ADC output of the MPL115A

a0 is the pressure offset coefficient

b1 is the pressure sensitivity coefficient

b2 is the temperature coefficient of offset (TCO)

c12 is the temperature coefficient of sensitivity (TCS)

Pcomp will produce a value of 0 with an input pressure of 50 kPa and will produce a full-scale value of 1023 with an input pressure of 115 kPa.

$$\text{Pressure (kPa)} = P_{comp} \cdot \left[ \frac{115 - 50}{1023} \right] + 50$$

**Eqn. 2**

## 3.3 Evaluation Sequence, Arithmetic Circuits

The following is an example of the calculation for Pcomp, the compensated pressure output. Input values are in **bold**.

$$c_{12}x_2 = \mathbf{c12} * \mathbf{Tadc}$$

$$a_1 = \mathbf{b1} + c_{12}x_2$$

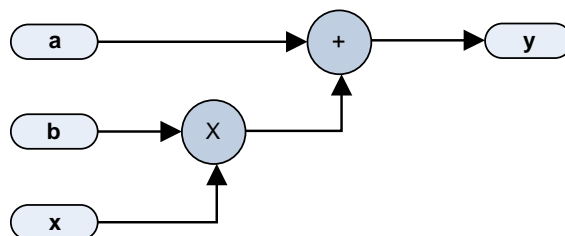
$$a_1x_1 = a_1 * \mathbf{Padc}$$

$$y_1 = \mathbf{a0} + a_1x_1$$

$$a_2x_2 = \mathbf{b2} * \mathbf{Tadc}$$

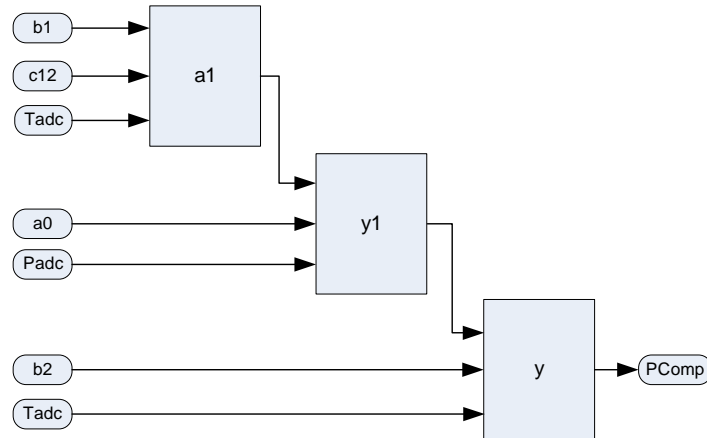
$$P_{comp} = y_1 + a_2x_2$$

This can be calculated as a succession of Multiply Accumulates (MACs) operations of the form  $y = a + b * x$ :



The polynomial can be evaluated (Equation 1) as a sequence of 3 MACs:

$$P_{comp} = a_0 + (b_1 + c_{12} \cdot T_{adc}) \cdot P_{adc} + b_2 \cdot T_{adc}$$



Please refer to Freescale application note AN3785 for more detailed notes on implementation.

### 3.4 I<sup>2</sup>C Device Read/Write Operations

All device read/write operations are memory mapped. Device actions e.g. “Start Conversions” are controlled by writing to the appropriate memory address location.

- For I<sup>2</sup>C the 7-bit Device Address (from Table 2) has a read/write toggle bit, where the least significant bit is ‘1’ for read operations or ‘0’ for write operations. The Device Address is 0xC0 for a *Write* and the Device Address is 0xC1 for a *Read*.
- The most significant bit in the Command tables below is not used and is don't care (X). In examples given it's set to ‘0’.

Refer to Sensor I<sup>2</sup>C Setup and FAQ Application Note AN4481 for more information on I<sup>2</sup>C communication between the sensor and host controller.

**Table 3. I<sup>2</sup>C Write Commands**

Command	Binary	HEX <sup>(1)</sup>
Devices Address + Write bit	1100 0000	0xC0
Start Conversions	X001 0010	0x12

X = Don't care

1 = The command byte needs to be paired with a 0x00 as part of the I<sup>2</sup>C exchange to complete the passing of Start Conversions.

The actions taken by the part in response to each command are as follows:

**Table 4. I<sup>2</sup>C Write Command Description**

Command	Action Taken
Start Conversions	Wake main circuits. Start clock. Allow supply stabilization time. Select pressure sensor input. Apply positive sensor excitation and perform A to D conversion. Select temperature input. Perform A to D conversion. Load the Pressure and Temperature registers with the result. Shut down main circuits and clock.

**Table 5. I<sup>2</sup>C Read Command Description**

Command	Binary	HEX <sup>(1)</sup>
Device Address + Read bit	1100 0001	0xC1
Read Pressure MSB	X000 0000	0x00
Read Pressure LSB	X000 0001	0x01
Read Temperature MSB	X000 0010	0x02
Read Temperature LSB	X000 0011	0x03
Read Coefficient data byte 1	X000 0100	0x04

X = don't care

These are MPL115A2 I<sup>2</sup>C commands to read coefficients, execute Pressure and Temperature conversions, and to read Pressure and Temperature data. The sequence of the commands for the interaction is given as an example to operate the MPL115A2.

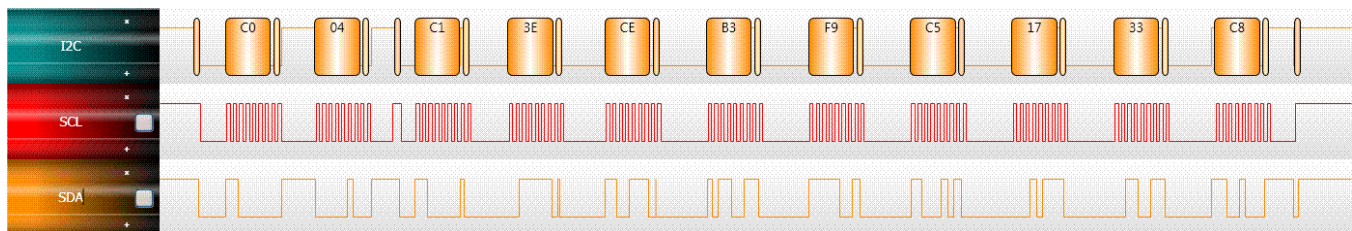
Utilizing this gathered data, an example of the calculating the Compensated Pressure reading is given in floating point notation.

**I<sup>2</sup>C Commands (simplified for communication)**

- Device Address + write bit "To Write" = 0xC0
- Device Address + read bit "To Read" = 0xC1
- Command to Write "Convert Pressure and Temperature" = 0x12
- Command to Read "Pressure ADC High byte" = 0x00
- Command to Read "Pressure ADC Low byte" = 0x01
- Command to Read "Temperature ADC High byte" = 0x02
- Command to Read "Temperature ADC Low byte" = 0x03
- Command to Read "Coefficient data byte 1 High byte" = 0x04

**Read Coefficients:**

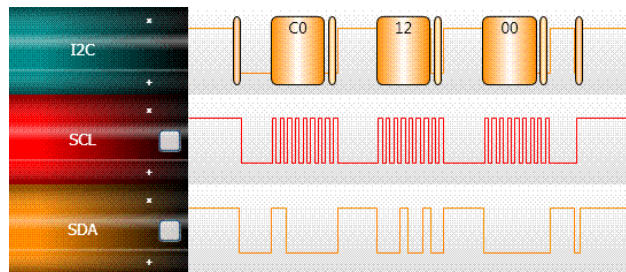
[0xC0], [0x04], [0xC1], [0x3E], [0xCE], [0xB3], [0xF9], [0xC5], [0x17], [0x33], [0xC8]



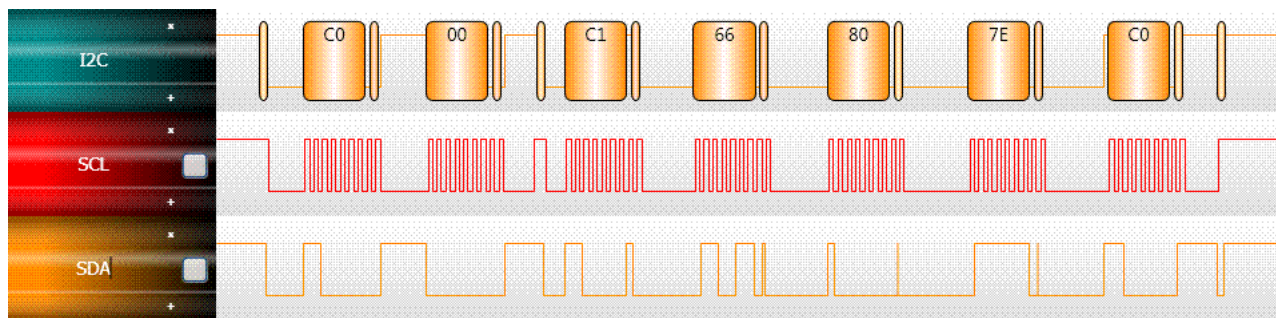
**Figure 3. I<sup>2</sup>C Read Coefficient Datagram**



a0 coefficient MSB = 0x3E  
 a0 coefficient LSB = 0xCE a0 coefficient = 0x3ECE = 2009.75  
  
 b1 coefficient MSB = 0xB3  
 b1 coefficient LSB = 0xF9 b1 coefficient = 0xB3F9 = -2.37585  
  
 b2 coefficient MSB = 0xC5  
 b2 coefficient LSB = 0x17 b2 coefficient = 0xC517 = -0.92047  
  
 c12 coefficient MSB = 0x33  
 c12 coefficient LSB = 0xC8 c12 coefficient = 0x33C8 = 0.000790



**Figure 4. I<sup>2</sup>C Start Conversion Datagram**  
Command to I<sup>2</sup>C Start Conversion, 0x12



**Figure 5. I<sup>2</sup>C Read Results Datagram**

Pressure MSB = 0x66  
 Pressure LSB = 0x80 Pressure = 0x6680 = 0110 0110 1100 0000  
 = 410 ADC counts  
  
 Temperature MSB = 0x7E  
 Temperature LSB = 0xC0 Temperature = 0x7EC0 = 0111 1110 1100 0000  
 = 507 ADC counts

### 3.5 Example of Pressure Compensated Calculation in Floating-point Notation

a0 coefficient = 2009.75  
b1 coefficient = -2.37585  
b2 coefficient = -0.92047  
c12 coefficient = 0.000790

Pressure = 410 ADC counts  
Temperature = 507 ADC counts

#### Pressure Compensation:

$$P_{\text{comp}} = a_0 + (b_1 + c_{12} \cdot T_{\text{adc}}) \cdot P_{\text{adc}} + b_2 \cdot T_{\text{adc}}$$

#### Using the evaluation sequence shown in Section 3.3:

$$\begin{aligned}c_{12}x_2 &= c_{12} \cdot T_{\text{adc}} = 0.000790 \cdot 507 &&= 0.40053 \\a_1 &= b_1 + c_{12}x_2 = -2.37585 + 0.40053 &&= -1.97532 \\a_1x_1 &= a_1 \cdot P_{\text{adc}} = -1.97532 \cdot 410 &&= -809.8812 \\y_1 &= a_0 + a_1x_1 = 2009.75 + (-809.8812) &&= 1199.8688 \\a_2x_2 &= b_2 \cdot T_{\text{adc}} = -0.92047 \cdot 507 &&= -466.67829 \\P_{\text{Comp}} &= y_1 + a_2x_2 = 1199.8688 + (-466.67829) &&= 733.19051\end{aligned}$$

$$\begin{aligned}\text{Pressure (kPa)} &= P_{\text{comp}} \cdot \left[ \frac{115 - 50}{1023} \right] + 50 \\&= 733.19 \cdot \left[ \frac{115 - 50}{1023} \right] + 50 \\&= 96.59 \text{ kPa}\end{aligned}$$

## 4 Solder Recommendations

1. Use SAC solder alloy (i.e., Sn-Ag-Cu) with a melting point of about 217°C. It is recommended to use SAC305 (i.e., Sn-3.0 wt.% Ag-0.5 wt.% Cu).
2. Reflow
  - Ramp up rate: 2 to 3°C/s.
  - Preheat flat (soak): 110 to 130s.
  - Reflow peak temperature: 250°C to 260°C (depends on exact SAC alloy composition).
  - Time above 217°C: 40 to 90s (depends on board type, thermal mass of the board/quantities in the reflow).
  - Ramp down: 5 to 6°C/s.
  - Using an inert reflow environment (with O<sub>2</sub> level about 5 to 15 ppm).

**NOTE:** The stress level and signal offset of the device also depends on the board type, board core material, board thickness and metal finishing of the board.

Please refer to Freescale application note AN3150, Soldering Recommendations for Pressure Sensor Devices for any additional information.

## 5 Handling Recommendations

It is recommended to handle the MPL115A pressure sensor with a vacuum pick and place tool. Sharp objects utilized to move the MPL115A pressure sensor increase the possibility of damage via a foreign object/tool into the small exposed port.

The sensor die is sensitive to light exposure. Direct light exposure through the port hole can lead to varied accuracy of pressure measurement. Avoid such exposure to the port during normal operation.

Please note that the Pin 1 designator is on the bottom of the package. Do not use the port as an orientation reference in production.

## 6 Soldering/Landing Pad Information

The LGA package is compliant with the RoHS standard. It is recommended to use a no-clean solder paste to reduce cleaning exposure to high pressure and chemical agents that can damage or reduce life span of the Pressure sensing element.

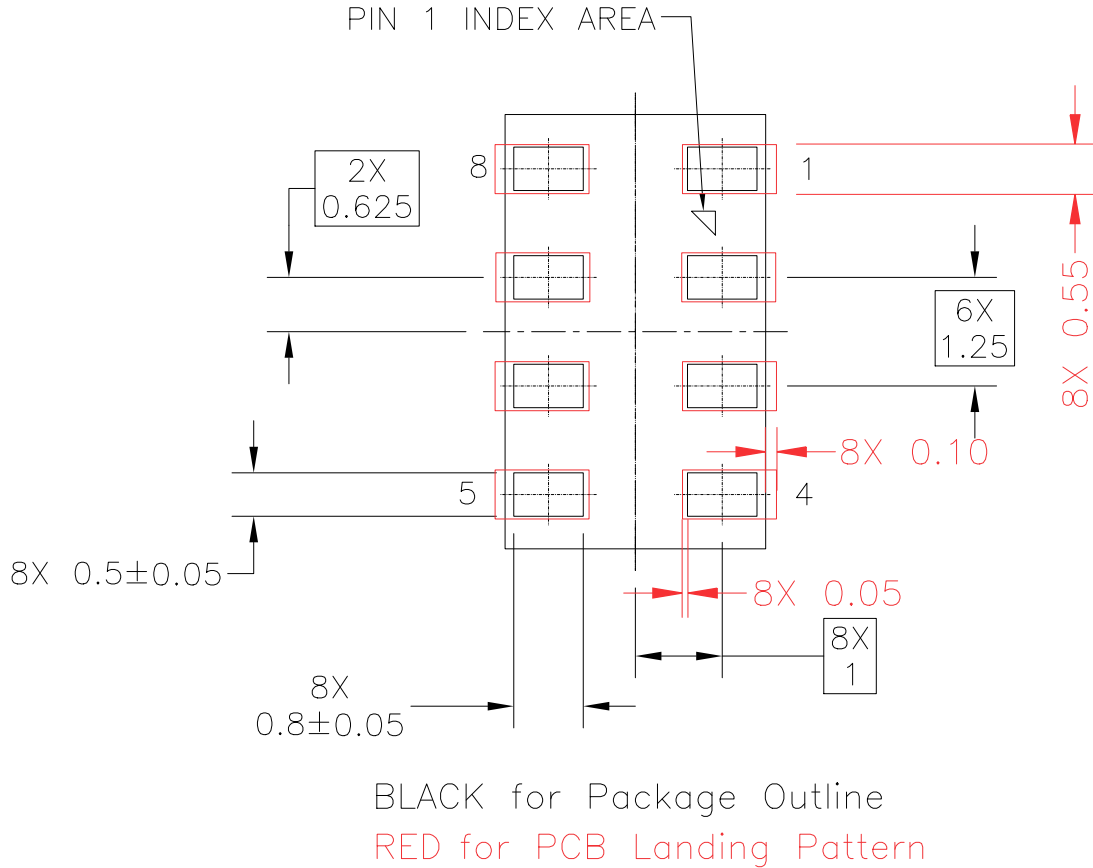


Figure 6. MPL115A2 Recommended PCB Landing Pattern

## 7 Tape and Reel Specifications

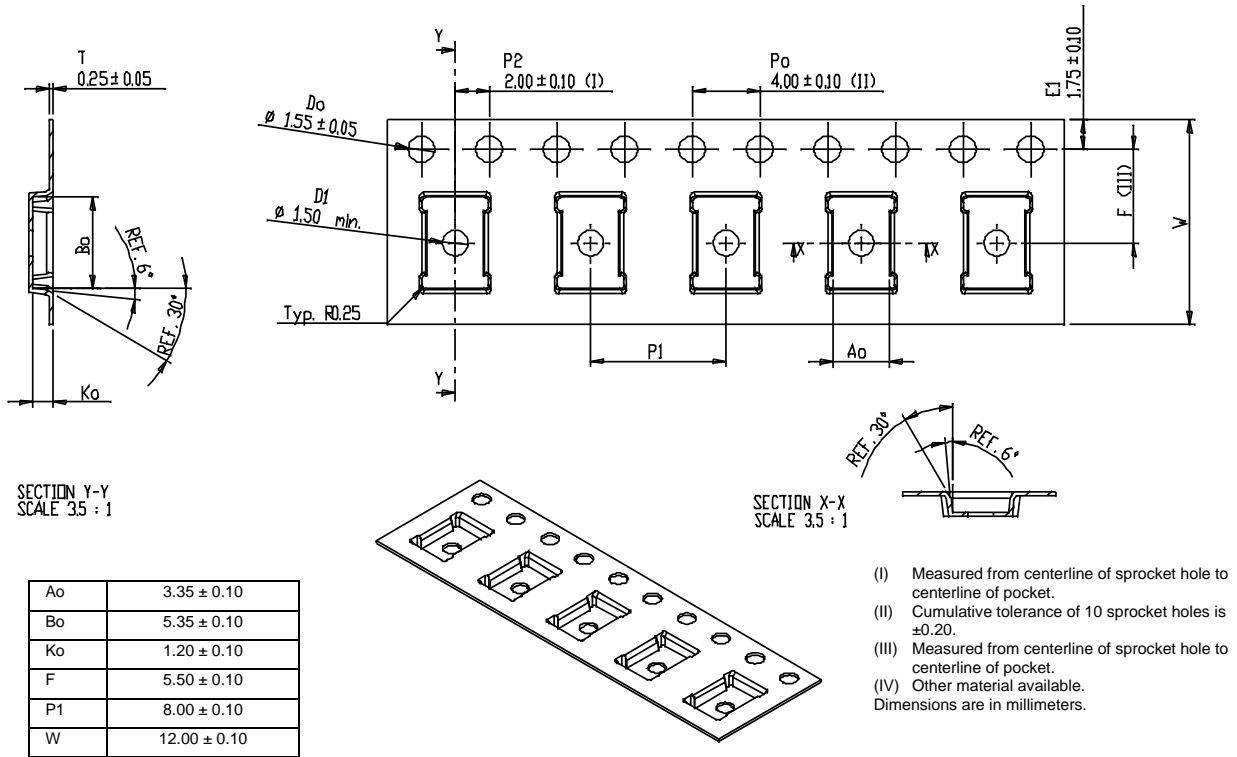


Figure 7. LGA (3 by 5) Embossed Carrier Tape Dimensions

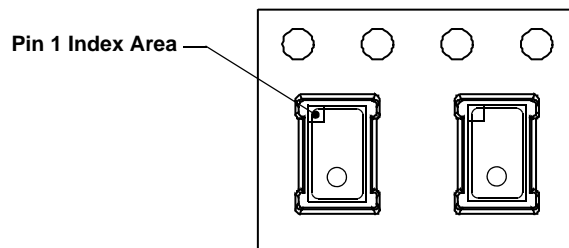
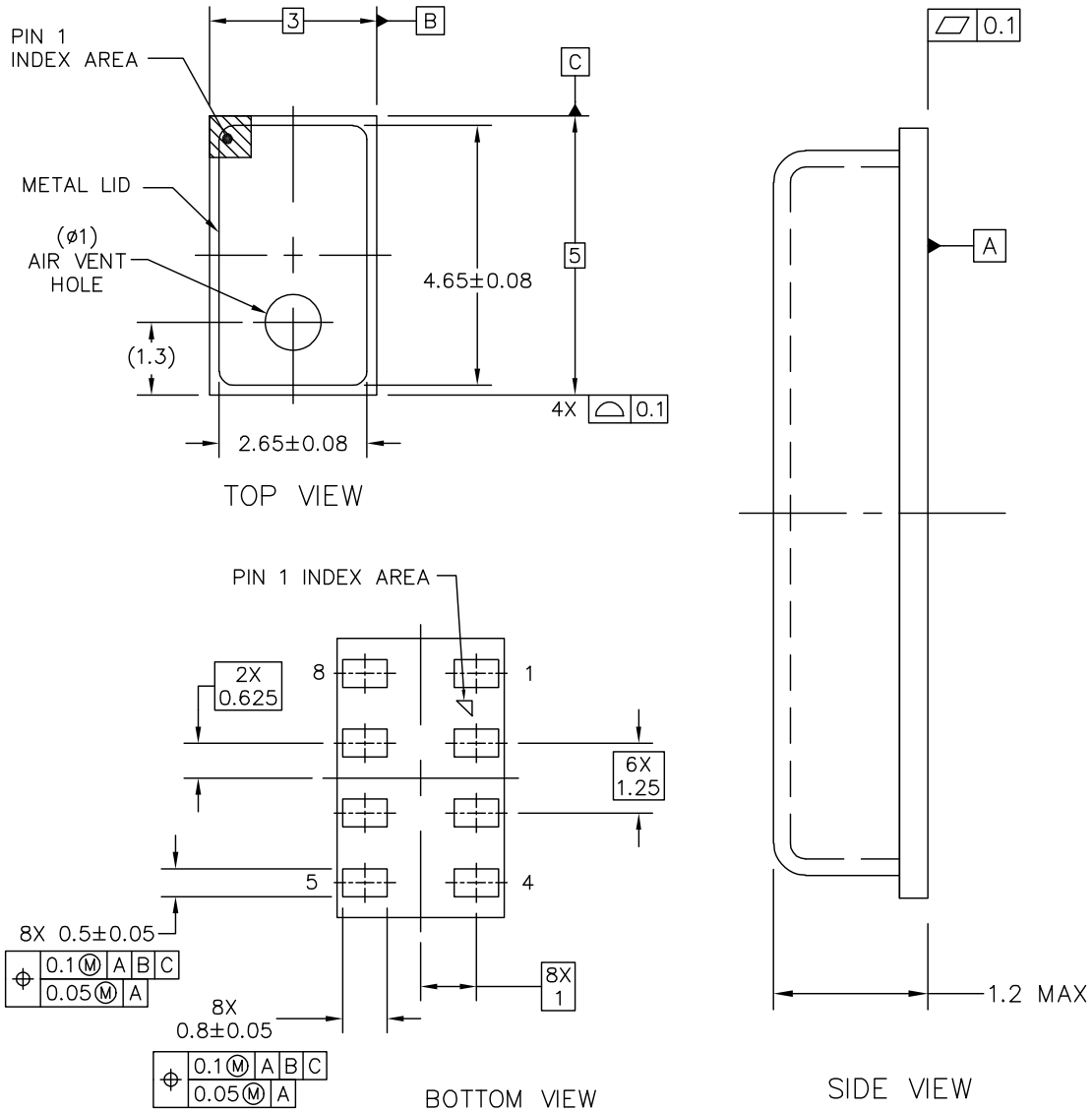


Figure 8. Device Orientation in Chip Carrier

## PACKAGE DIMENSIONS



**NOTES:**

1. ALL DIMENSIONS IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994

© FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED.	<b>MECHANICAL OUTLINE</b>	PRINT VERSION NOT TO SCALE
TITLE: LGA 8 I/O, 3 X 5 X 1.25 PITCH, SENSOR 1.2MAX MM PKG	DOCUMENT NO: 98ASA10829D	REV: A
	CASE NUMBER: 2015-02	10 MAR 2010
	STANDARD: NON-JEDEC	

**CASE 2015-02  
ISSUE A  
LGA PACKAGE**

## Related Documentation

The MPL115A2 device features and operations are described in a variety of reference manuals, user guides, and application notes. To find the most-current versions of these documents:

1. Go to the Freescale homepage at:  
<http://www.freescale.com/>
2. In the Keyword search box at the top of the page, enter the device number MPL115A2.
3. In the Refine Your Result pane on the left, click on the Documentation link.

**Table 6. Revision History**

Revision number	Revision date	Description of changes
8	06/2012	<ul style="list-style-type: none"><li>• Updated graphic on page 1, Section 2.2 Operating Characteristics: Ref 7: Conversion Time: changed Typ from 3.0 to 1.6, Section 3.0 Overview of Functions/Operation: Reading Coefficient Data deleted statement that reading of coefficients may be executed only once, Table 2: added Size (bits) column in table, added new Section 3.4 I<sup>2</sup>C Device Read/Write Operations</li></ul>
		<ul style="list-style-type: none"><li>•</li></ul>
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